RN2903

Low-Power Long Range LoRa® Technology Transceiver Module

Features

- On-Board LoRaWAN™ Protocol Stack
- ASCII Command Interface over UART
- Compact Form Factor: 17.8 x 26.7 x 3.34 mm
- Castellated SMT Pads for Easy and Reliable PCB Mounting
- Environmentally Friendly, RoHS Compliant
- Compliance:
  - Modular Certified for the United States (FCC) and Canada (IC)
  - Taiwan
- Device Firmware Upgrade (DFU) over UART, see *"RN2903 LoRa® Technology Module Command Reference User's Guide"* (DS40001811)

Operational

- Single Operating Voltage: 2.1V to 3.6V (3.3V typical)
- Temperature Range: -40°C to +85°C
- Low-Power Consumption
- Programmable RF Communication Bit Rate up to 300 kbps with FSK Modulation, 12500 bps with LoRa® Technology Modulation
- Integrated MCU, Crystal, EUI-64 Node Identity Serial EEPROM, Radio Transceiver with Analog Front End, Matching Circuitry
- 14 GPIOs for Control and Status, Shared with 13 Analog Inputs

RF/Analog Features

- Low-Power Long Range Transceiver Operating in the 915 MHz Frequency Band
- High Receiver Sensitivity: Down to -146 dBm
- TX Power: Adjustable up to +18.5 dBm High Efficiency PA
- FSK, GFSK, and LoRa Technology Modulation
- IIP3 = -11 dBm
- Up to 15 km Coverage at Suburban and up to 5 km Coverage at Urban Area



General Description

Microchip's RN2903 Low-Power Long Range LoRa Technology Transceiver module provides an easy to use, low-power solution for long range wireless data transmission. The advanced command interface offers rapid time to market.

The RN2903 module complies with the LoRaWAN Class A protocol specifications. It integrates RF, a baseband controller, command Application Programming Interface (API) processor, making it a complete long range solution.

The RN2903 module is suitable for simple long range sensor applications with external host MCU.

Applications

- Automated Meter Reading
- Home and Building Automation
- Wireless Alarm and Security Systems
- Industrial Monitoring and Control
- Machine to Machine (M2M)
- Internet of Things (IoT)

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1.0 DEVICE OVERVIEW

The RN2903 transceiver module features LoRa Technology RF modulation, which provides long range spread spectrum communication with high interference immunity.

Using LoRa Technology modulation technique, RN2903 can achieve a receiver sensitivity of -146 dBm. The high sensitivity combined with the integrated +18.5 dBm output power amplifier yields industry leading link budget, which makes it optimal for applications requiring extended range and robustness.

LoRa Technology modulation also provides significant advantages in both blocking and selectivity compared to the conventional modulation techniques, solving the traditional design compromise between extended range, interference immunity, and low-power consumption.

The RN2903 module delivers exceptional phase noise, selectivity, receiver linearity, and IIP3 for significantly lower power consumption. The level of conductive harmonics is below -70 dBm. Figure 1-1, Figure 1-2 and Figure 1-3 show the top view, the pinout, and the block diagram of the module.

FIGURE 1-1: RN2903 TOP VIEW

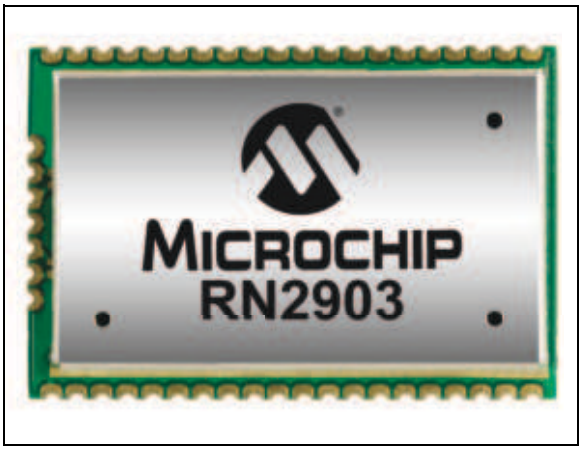


FIGURE 1-2: RN2903 PIN DIAGRAM

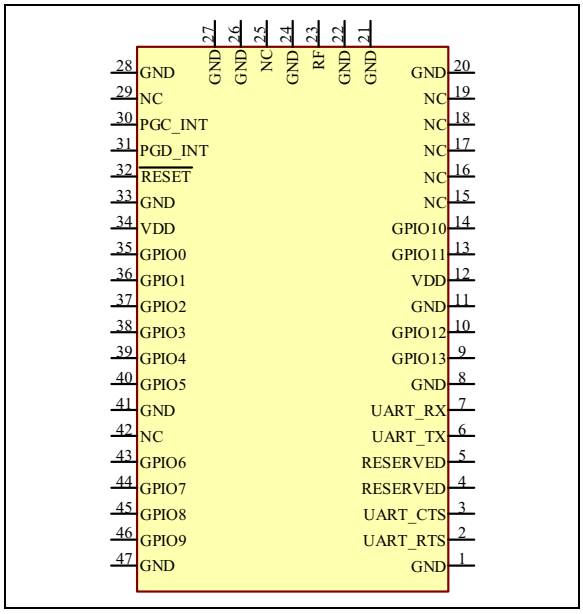
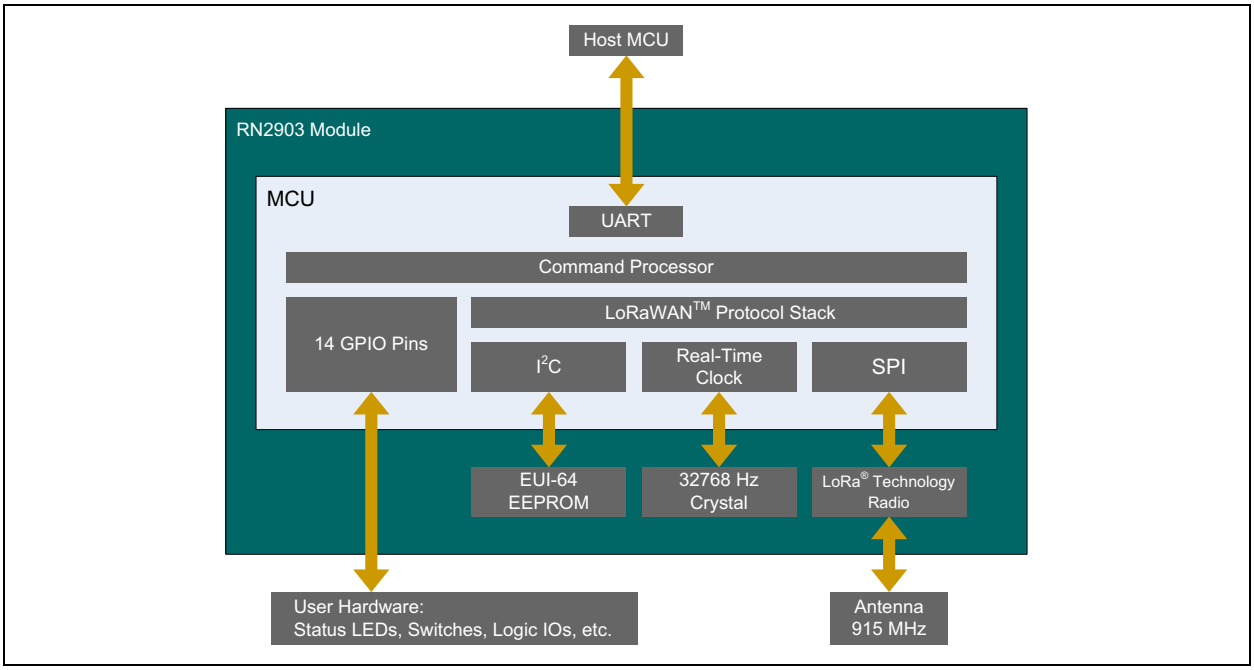


FIGURE 1-3: RN2903 BLOCK DIAGRAM



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Table 1-1 describes the RN2903 pins.

TABLE 1-1: PIN DESCRIPTION

Pin	Name	Type	Description
1	GND	Power	Ground supply terminal
2	UART_RTS	Output	Communication UART RTS signal(1), or GPIO
3	UART_CTS	Input	Communication UART CTS signal(1), or GPIO
4	RESERVED	—	Do not connect
5	RESERVED	—	Do not connect
6	UART_TX	Output	Communication UART Transmit (TX)
7	UART_RX	Input	Communication UART Receive (RX)
8	GND	Power	Ground supply terminal
9	GPIO13	Input/Output	General purpose I/O pin or analog input
10	GPIO12	Input/Output	General purpose I/O pin or analog input
11	GND	Power	Ground supply terminal
12	VDD	Power	Positive supply terminal
13	GPIO11	Input/Output	General purpose I/O pin or analog input
14	GPIO10	Input/Output	General purpose I/O pin or analog input
15	NC	—	Not connected
16	NC	—	Not connected
17	NC	—	Not connected
18	NC	—	Not connected
19	NC	—	Not connected
20	GND	Power	Ground supply terminal
21	GND	Power	Ground supply terminal
22	GND	Power	Ground supply terminal
23	RF	RF analog	RF signal pin
24	GND	Power	Ground supply terminal
25	NC	—	Not connected
26	GND	Power	Ground supply terminal
27	GND	Power	Ground supply terminal
28	GND	Power	Ground supply terminal
29	NC	—	Not connected
30	PGC_INT	Input/Ouput	Internal MCU ICSP program clock or general purpose I/O pin
31	PGD_INT	Input/Ouput	Internal MCU ICSP program data or general purpose I/O pin
32	$\overline{\text{RESET}}$	Input	Active-low device Reset input
33	GND	Power	Ground supply terminal
34	VDD	Power	Positive supply terminal
35	GPIO0	Input/Output	General purpose I/O pin or analog input
36	GPIO1	Input/Output	General purpose I/O pin or analog input
37	GPIO2	Input/Output	General purpose I/O pin or analog input
38	GPIO3	Input/Output	General purpose I/O pin or analog input
39	GPIO4	Input/Output	General purpose I/O pin
40	GPIO5	Input/Output	General purpose I/O pin or analog input
41	GND	Power	Ground supply terminal
42	NC	—	Not connected
43	GPIO6	Input/Output	General purpose I/O pin or analog input

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TABLE 1-1: PIN DESCRIPTION (CONTINUED)

Pin	Name	Type	Description
44	GPIO7	Input/Output	General purpose I/O pin or analog input
45	GPIO8	Input/Output	General purpose I/O pin or analog input
46	GPIO9	Input/Output	General purpose I/O pin or analog input
47	GND	Power	Ground supply terminal

Note 1: Optional handshake lines are supported in future firmware releases.

2.0 GENERAL SPECIFICATIONS

Table 2-1 provides the general specifications for the module. Table 2-2, Table 2-3, and Table 2-4 provide the electrical characteristics, current consumption, and dimensions of the module, respectively. Table 2-5 shows the RF output power calibration data. Table 2-6 shows the RF output power at different supply voltages and temperatures.

TABLE 2-1: GENERAL SPECIFICATIONS

Specification	Description
Frequency Band	902.000 MHz to 928.000 MHz
Modulation Method	FSK, GFSK, and LoRa® Technology modulation
Maximum Over-the-Air Data Rate	300 kbps with FSK modulation; 12500 bps with LoRa Technology modulation
RF Connection	Board edge connection
Interface	UART
Operation Range	Up to 15 km coverage at suburban; up to 5 km coverage at urban area
Sensitivity at 1% PER	-146 dBm(1)
RF TX Power	Adjustable up to max. +18.5 dBm on 915 MHz band(2)
Generated Conductive Harmonics Level	Below -70 dBm
Temperature (operating)	-40°C to +85°C
Temperature (storage)	-40°C to +115°C
Humidity	10% ~ 90% non-condensing

Note 1: Dependent on modulation settings, Receiver Bandwidth (RBW), and Spreading Factor (SF).

2: TX power is adjustable. For more information, refer to the *"RN2903 LoRa® Technology Module Command Reference User's Guide"* (DS40001811).

TABLE 2-2: ELECTRICAL CHARACTERISTICS

Parameter	Min.	Typ.	Max.	Units
Supply Voltage	2.1	—	3.6	V
Voltage on any pin with respect to VSS (except VDD and $\overline{\text{RESET}}$)	-0.3	—	VDD + 0.3	V
Voltage on VDD with respect to VSS	-0.3	—	3.9	V
Voltage on $\overline{\text{RESET}}$ with respect to VSS	0	—	+11	V
Input Clamp Current (IIK) (VI < 0 or VI > VDD)	—	—	+/-20	mA
Output Clamp Current (IOK) (VO < 0 or VO > VDD)	—	—	+/-20	mA
GPIO sink/source current each	—	—	25/25	mA
Total GPIO sink/source current	—	—	200/185	mA
RAM Data Retention Voltage (in Sleep mode or Reset state)	1.5	—	—	V
VDD Start Voltage to ensure internal Power-on Reset signal	—	—	0.7	V
VDD Rise Rate to ensure internal Power-on Reset signal	0.05	—	—	V/ms
Brown-out Reset Voltage	1.75	1.9	2.05	V
Logic Input Low Voltage	—	—	0.15 x VDD	V
Logic Input High Voltage	0.8 x VDD	—	—	V
Input Leakage at <25°C (VSS<VPIN<VDD, Pin at high-impedance)	—	0.1	50	nA
Input Leakage at +60°C (VSS<VPIN<VDD, Pin at high-impedance)	—	0.7	100	nA
Input Leakage at +85°C (VSS<VPIN<VDD, Pin at high-impedance)	—	4	200	nA
RF Input Level	—	—	+10	dBm

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TABLE 2-3: CURRENT CONSUMPTION

Mode	Temperature (°C)	Typical Current (mA)		
		VDD = 2.1V	VDD = 3.3V	VDD = 3.6V
Idle	-40 to +85	1.8	2.8	3.1
Transmit	-40 to +85	105	121	122
Deep Sleep	-40	0.0009	0.0010	0.0012
	25	0.0011	0.0013	0.0014
	85	0.0026	0.0032	0.0036

TABLE 2-4: MODULE DIMENSIONS

Parameter	Value
Dimensions	17.8 x 26.7 x 3.34 mm
Weight	2.05g

TABLE 2-5: OUTPUT POWER OF TX POWER SETTING

TX Power Setting	Output Power (dBm)	Typical Supply Current at 3.3V (mA)
2	3.0	42.6
3	4.0	44.8
4	5.0	47.3
5	6.0	49.6
6	7.0	52.0
7	8.0	55.0
8	9.0	57.7
9	10.0	61.0
10	11.0	64.8
11	12.0	73.1
12	13.0	78.0
14	14.7	83.0
15	15.5	88.0
16	16.3	95.8
17	17.0	103.6
20	18.5	124.4

TABLE 2-6: OUTPUT POWER OF SUPPLY VOLTAGE AND TEMPERATURE

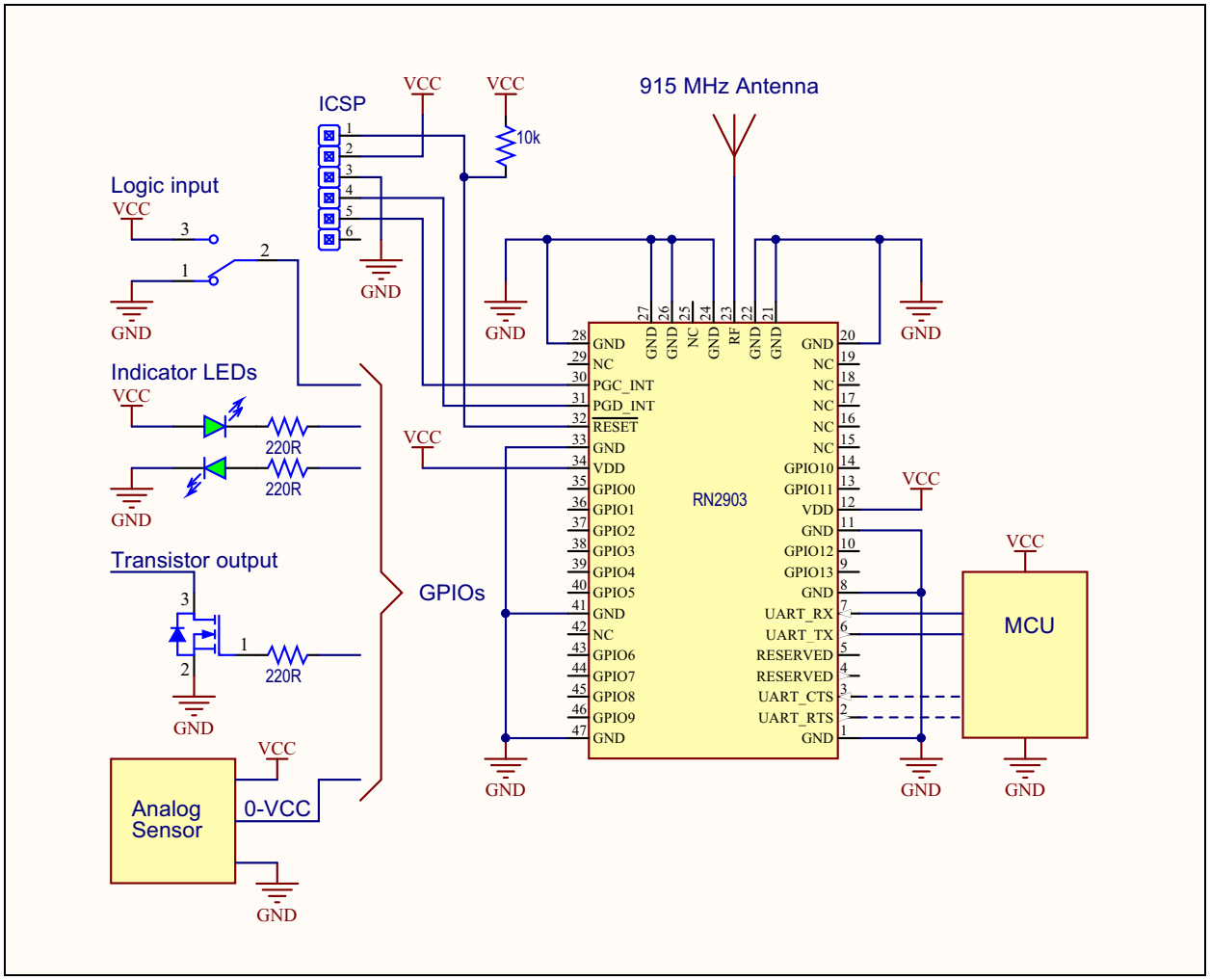
Temperature (°C)	Typical Output Power (dBm)		
	VDD = 2.1V	VDD = 3.3V	VDD = 3.6V
-40	18.0	18.6	18.7
25	17.1	18.0	18.1
85	16.3	17.3	17.3

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3.0 TYPICAL HARDWARE CONNECTIONS

Figure 3-1 shows the typical hardware connections.

FIGURE 3-1: HARDWARE CONNECTIONS



3.1 Interface to Host MCU

The RN2903 module has a dedicated UART interface to communicate with a host controller. Optional handshake lines are supported in future firmware releases. The *"RN2903 LoRa® Technology Module Command Reference User's Guide"* (DS40001811) provides a detailed UART command description. Table 3-1 shows the default settings for the UART communication.

TABLE 3-1: DEFAULT UART SETTINGS

Specification	Description
Baud Rate	57600 bps
Packet Length	8 bit
Parity Bit	No
Stop Bits	1 bit
Hardware Flow Control	No

3.2 GPIO Pins (GPIO0–GPIO13)

The module has 14 GPIO pins. These lines can be connected to switches, LEDs, and relay outputs. The pins can be either logic inputs or outputs, and some pins (see Table 1-1) have analog input capability that can be accessed via the module firmware. These pins have limited sink and source capabilities. Electrical characteristics are described in Table 2-2. For more information, see *"RN2903 LoRa® Technology Module Command Reference User's Guide"* (DS40001811).

3.3 RF Connection

When routing RF path, use proper strip lines with an impedance of 50 Ohm.

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3.4 $\overline{\text{RESET}}$ Pin

The $\overline{\text{RESET}}$ pin of the module is an active-low logic input. An internal weak pull-up resistor is enabled when the pin is configured as the MCLR input.

3.5 Power Pins

It is recommended to connect power pins (Pin 12 and Pin 34) to a stable supply voltage with sufficient source current. Table 2-3 shows the current consumption.

Additional filtering capacitors are not required but used to ensure stable supply voltage in a noisy environment.

3.6 Internal Program Pins

PGC_INT (Pin 30) and PGD_INT (Pin 31) are internal program pins used during manufacturing. For normal operation, these pins can be left unconnected.

The normal firmware upgrade method is through the internal bootloader of the module via the UART. The method is documented in the *"RN2903 LoRa® Technology Module Command Reference User's Guide"* (DS40001811).

However, for backup firmware update purposes the user can place a 6-pin ICSP header on their host PCB with PGC_INT (Pin 30), PGD_INT (Pin 31), $\overline{\text{RESET}}$ (Pin 32), power and ground.

During High Voltage In-Circuit Serial Programming mode, the $\overline{\text{RESET}}$ pin is driven with high-voltage (9V), therefore protection may be necessary for sensitive devices.

Note:	Only official Microchip Technology firmware released for the RN2903 module shall be used to maintain FCC and IC certification.

4.0 PHYSICAL DIMENSIONS

Figure 4-1 and Figure 4-2 illustrate the physical dimensions and the recommended PCB layout for the RN2903 module.

FIGURE 4-1: RN2903 PHYSICAL DIMENSIONS

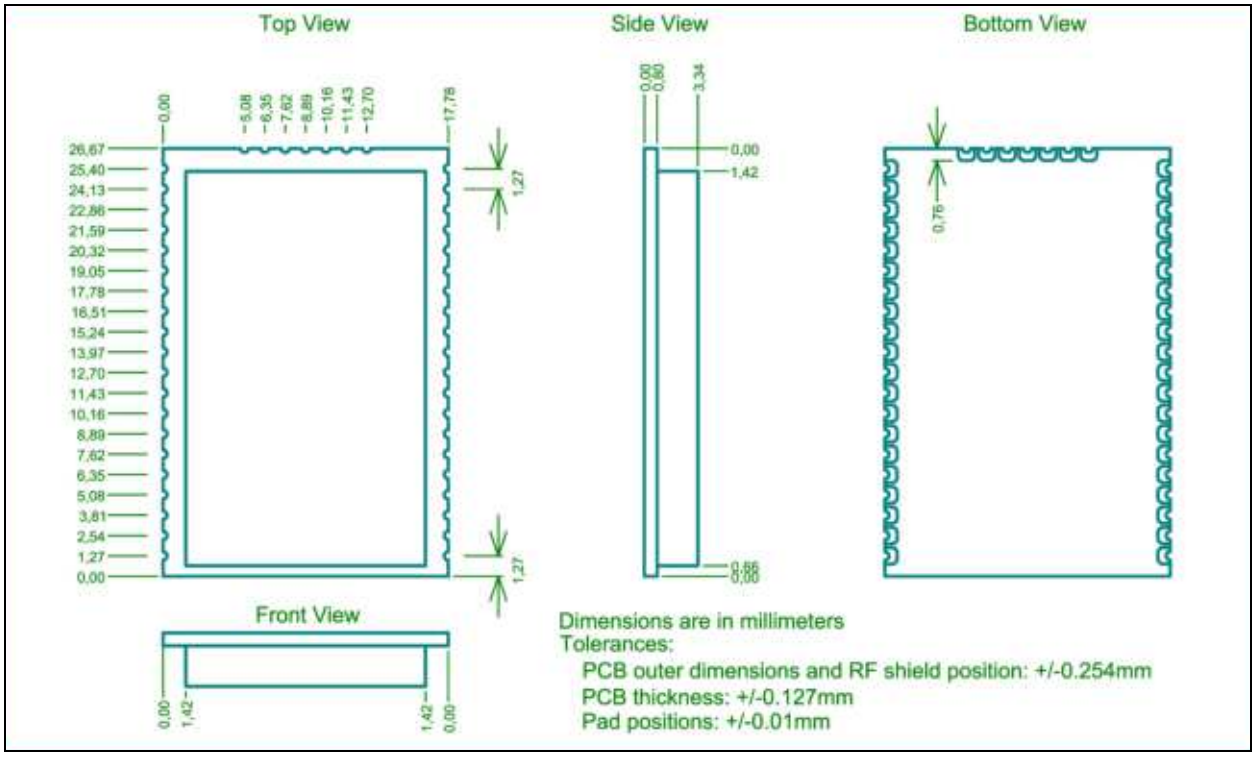
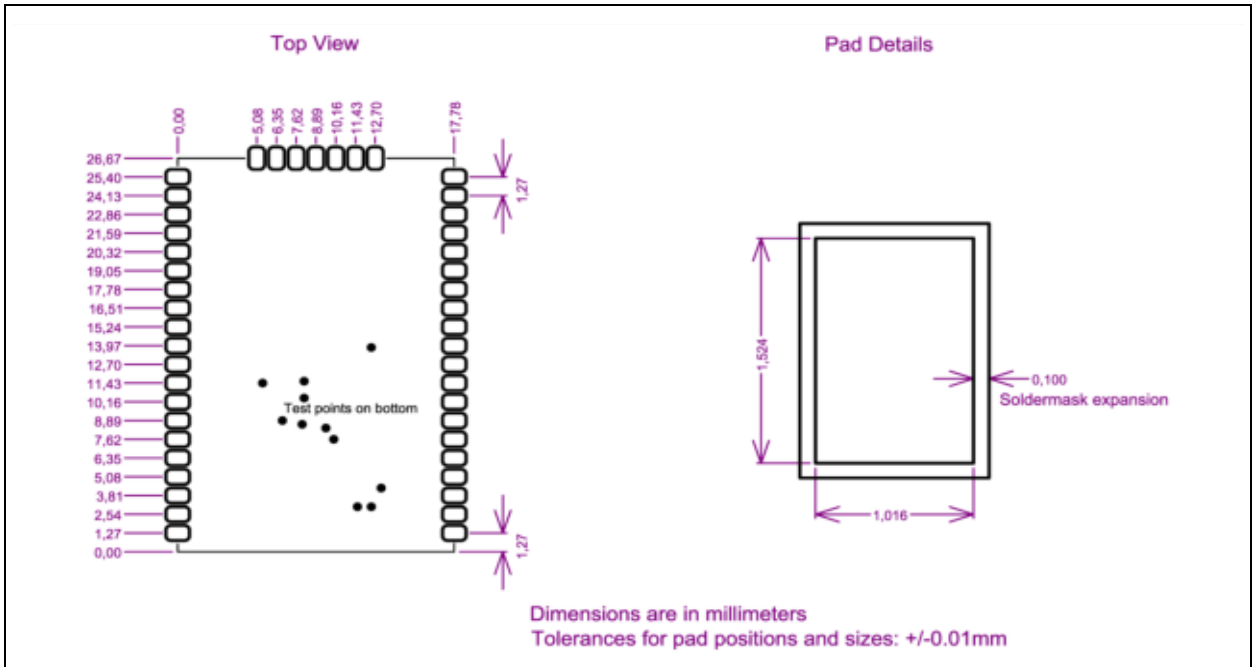


FIGURE 4-2: RECOMMENDED PCB FOOTPRINT



Note: Host PCB top layer copper traces must have solder mask to avoid shorting test pins on the bottom of the module.

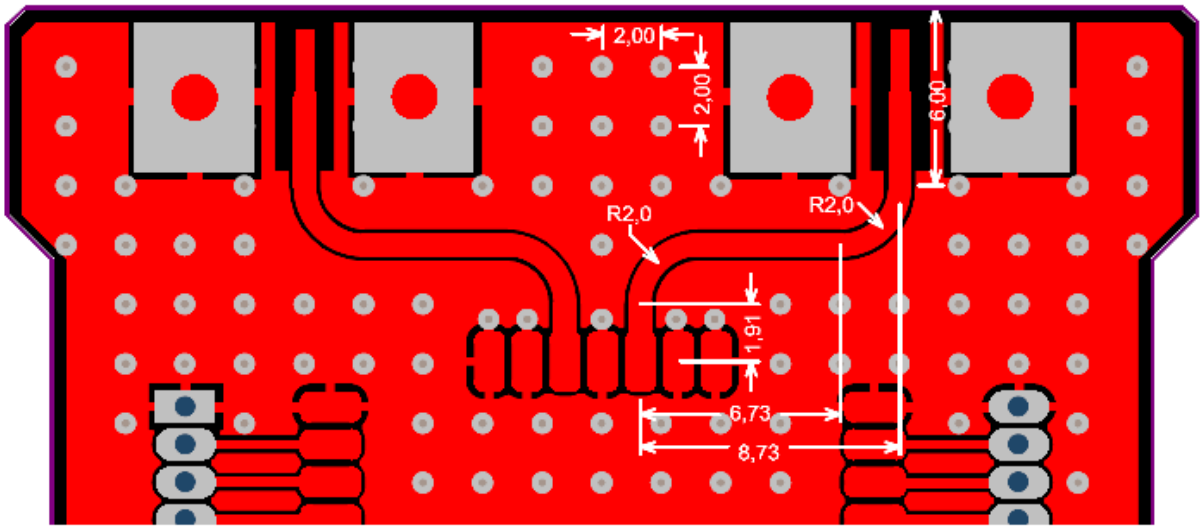
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5.0 APPLICATION INFORMATION

5.1 RF Trace Layout Design

The RN2903 modular transmitter is certified with a PCB edge SMA connector and micro-strip trace layout as shown in Figure 5-1 and Figure 5-2. The left side RF path is not used for this module. The host PCB can follow these trace design to maintain compliance under the modular grant (FCC) and certificate (IC). Gerber files are available on the RN2903 product web page at www.microchip.com/rn2903.

FIGURE 5-1: RF TRACE ROUTING (TOP LAYER)

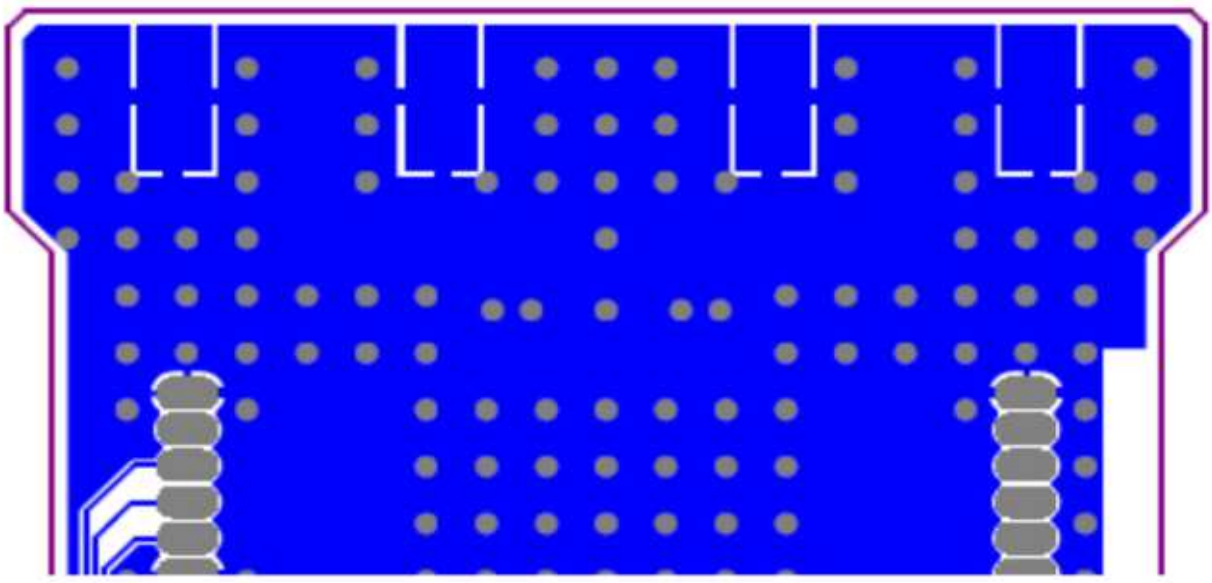


PCB Details:
- Two layer, plated through hole
- FR4
- Thickness: 1.55 mm
- Via stitching with 0.25 mm plated

Trace Dimensions:
- Trace width: 0.75
- Trace gap: 0.15
- Finished Copper Weight: 1 ounce

Dimensions are in millimeters

FIGURE 5-2: RF TRACE ROUTING (BOTTOM LAYER)



5.2 PCB Trace Antenna

Modular certification of the RN2903 module is performed with the PCB trace antenna as shown in Figure 5-3. The exact dimensions of the trace antenna must be followed. The PCB trace antenna is fabricated on the top copper layer and covered in solder mask. The layers below the antenna do not have copper trace. The PCB material is FR4 and the thickness is 0.062 inches (1.6 mm). The antenna has 50 ohm impedance and no matching is required. The supporting board must be 84 mm long and 53 mm wide in order to generate that impedance and the average gain of 1.3 dB. Gerber files for the PCB trace antenna are available on the RN2903 product web page on the Microchip web site at http://www.microchip.com/rn2903.

The antenna patterns plotted in Figure 5-4 through Figure 5-5 are the simulated results of the PCB antenna.

Figure 5-4 illustrates the two-dimensional (2D) radiation pattern. The calculated average gain is 1.3 dBi. The radiation pattern for the XZ plane is shown in red, whereas the YZ plane is shown in blue. The most powerful radiation occurs in the YZ plane as represented by the blue pattern.

Figure 5-5 illustrates the three-dimensional (3D) radiation pattern. The radiation pattern shows the relative position of the 3D radiation "donut" with reference to the module orientation. This is a very useful guide for placement of the module to obtain the maximum range.

FIGURE 5-3: PCB TRACE ANTENNA MEASUREMENTS

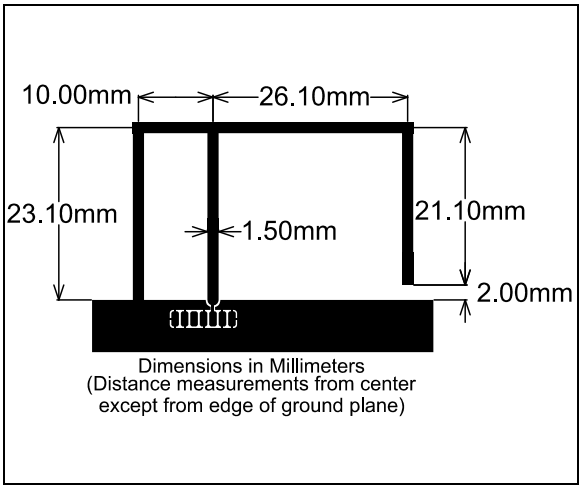
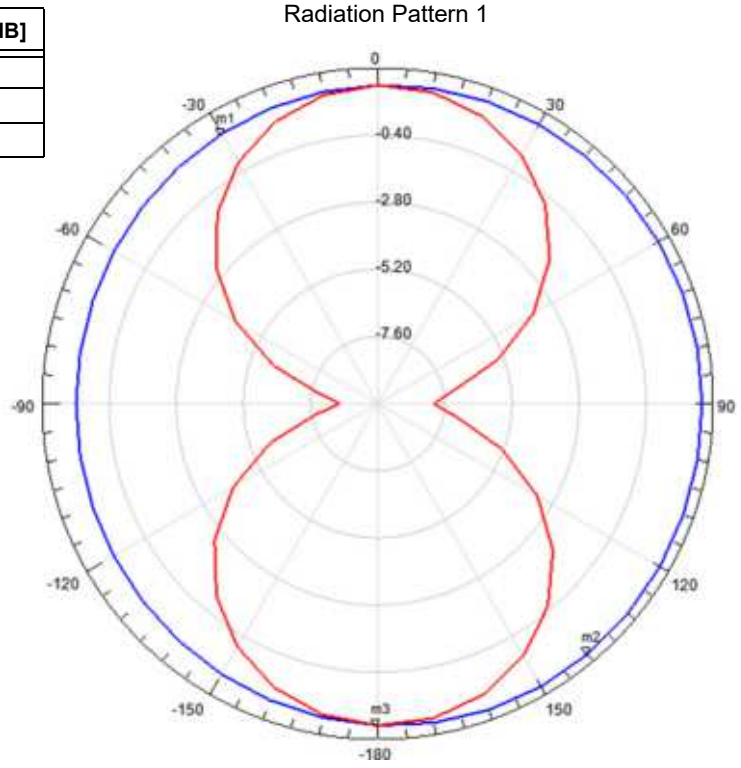


FIGURE 5-4: SIMULATED TWO-DIMENSIONAL RADIATION PATTERN

Name	Theta [deg]	Angle [deg]	Mag. [dB]
m1	330	-30	1.1
m2	140	140	1.7
m3	180	180	1.5

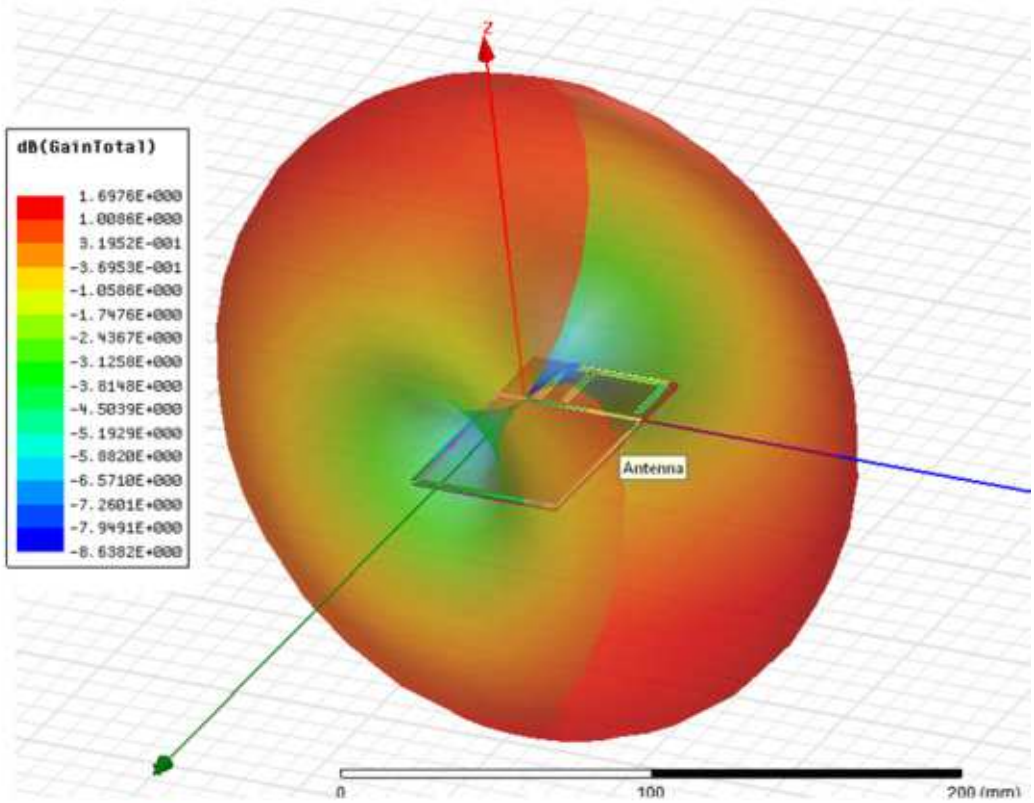
915 MHz F Ant for Module dimensions

Curve Information	Avg.
dB (Gain Total) Setup 1: Last Adaptive Freq. = 915 MHz Phi = '0 deg'	-2.3
dB (Gain Total) Setup 1: Last Adaptive Freq. = 915 MHz Phi = '90 deg'	1.3



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FIGURE 5-5: SIMULATED THREE-DIMENSIONAL RADIATION PATTERN



5.3 Approved Antennas

Modular certification of the RN2903 module is performed with the external antenna type in Table 5-1. For specific regulatory requirements by country, refer to **Section 6.0 "Regulatory Approval"**.

TABLE 5-1: TESTED EXTERNAL ANTENNA TYPES

Type	Gain (dBi)
Sleeve Dipole	6
PCB Trace	1.7

6.0 REGULATORY APPROVAL

This section outlines the regulatory information for the RN2903 module for the following countries:

- United States
- Canada
- Taiwan

6.1 United States

The RN2903 module has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C “Intentional Radiators” modular approval in accordance with Part 15.212 Modular Transmitter approval. Modular approval allows the end user to integrate the RN2903 module into a finished product without obtaining subsequent and separate FCC approvals for intentional radiation, provided no changes or modifications are made to the module circuitry. Changes or modifications could void the user's authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

The finished product is required to comply with all applicable FCC equipment authorizations regulations, requirements and equipment functions not associated with the transmitter module portion. For example, compliance must be demonstrated to regulations for other transmitter components within the host product; to requirements for unintentional radiators (Part 15 Subpart B “Unintentional Radiators”), such as digital devices, computer peripherals, radio receivers, etc.; and to additional authorization requirements for the non-transmitter functions on the transmitter module (i.e., Verification, or Declaration of Conformity) (e.g., transmitter modules may also contain digital logic functions) as appropriate.

6.1.1 LABELING AND USER INFORMATION REQUIREMENTS

The RN2903 module has been labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording as follows:

> Contains Transmitter Module FCC ID: T9JRN2903
>
> *or*
>
> Contains FCC ID: T9JRN2903
>
> This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

A user's manual for the finished product should include the following statement:

> This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:
>
> - Reorient or relocate the receiving antenna.
> - Increase the separation between the equipment and receiver.
> - Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
> - Consult the dealer or an experienced radio/TV technician for help.

Additional information on labeling and user information requirements for Part 15 devices can be found in KDB Publication 784748 available at the FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) https://apps.fcc.gov/oetcf/kdb/index.cfm.

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6.1.2 RF EXPOSURE

All transmitters regulated by FCC must comply with RF exposure requirements. KDB 447498 General RF Exposure Guidance provides guidance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC).

From the RN2903 FCC Grant: Output power listed is conducted. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. This transmitter is restricted for use with the specific antenna(s) tested in this application for Certification and must not be co-located or operating in conjunction with any other antenna or transmitters within a host device, except in accordance with FCC multi-transmitter product procedures.

6.1.3 APPROVED EXTERNAL ANTENNA TYPES

To maintain modular approval in the United States, only the antenna types that have been tested shall be used. It is permissible to use different antenna manufacturer provided the same antenna type and antenna gain (equal to or less than) is used.

Testing of the RN2903 module was performed with the antenna types listed in Table 5-1 Tested External Antenna Types.

6.1.4 HELPFUL WEB SITES

Federal Communications Commission (FCC): http://www.fcc.gov

FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB): https://apps.fcc.gov/oetcf/kdb/index.cfm

6.2 Canada

The RN2903 module has been certified for use in Canada under Industry Canada (IC) Radio Standards Specification (RSS) RSS-210 and RSS-Gen. Modular approval permits the installation of a module in a host device without the need to recertify the device.

6.2.1 LABELING AND USER INFORMATION REQUIREMENTS

Labeling Requirements for the Host Device (from Section 3.2.1, RSS-Gen, Issue 3, December 2010): The host device shall be properly labeled to identify the module within the host device.

The Industry Canada certification label of a module shall be clearly visible at all times when installed in the host device, otherwise the host device must be labeled to display the Industry Canada certification number of the module, preceded by the words “Contains transmitter module”, or the word “Contains”, or similar wording expressing the same meaning, as follows:

Contains transmitter module IC: 6514A-RN2903.

User Manual Notice for License-Exempt Radio Apparatus (from Section 7.1.3 RSS-Gen, Issue 3, December 2010): User manuals for license-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual or alternatively on the device or both:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device. Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Transmitter Antenna (from Section 7.1.2 RSS-Gen, Issue 3, December 2010): User manuals for transmitters shall display the following notice in a conspicuous location:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

The above notice may be affixed to the device instead of displayed in the user manual.

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User manuals for transmitters equipped with detachable antennas shall also contain the following notice in a conspicuous location:

> This radio transmitter (identify the device by certification number, or model number if Category II) has been approved by Industry Canada to operate with the antenna types listed below with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.
>
> Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Immediately following the above notice, the manufacturer shall provide a list of all antenna types approved for use with the transmitter, indicating the maximum permissible antenna gain (in dBi) and required impedance for each.

6.2.2 RF EXPOSURE

All transmitters regulated by IC must comply with RF exposure requirements listed in RSS-102 - Radio Frequency (RF) Exposure Compliance of Radiocommunication Apparatus (All Frequency Bands). Currently this device is approved for use for when 20 cm can be maintained between the antenna and users.

Specific Absorption Rate (SAR) evaluation is required if the separation distance between the user and/or bystander and the antenna and/or radiating element of the device is less than or equal to 20 cm. Exceptions are listed in RSS-102. Note that integration < 20 cm will require further certification with IC such as a Multiple listing and Class IV Permissive Change application.

6.2.3 APPROVED EXTERNAL ANTENNA TYPES

Transmitter Antenna (from Section 7.1.2 RSS-Gen, Issue 3, December 2010):

The RN2903 module can only be sold or operated with antennas with which it was approved. Transmitter may be approved with multiple antenna types. An antenna type comprises antennas having similar in-band and out-of-band radiation patterns. Testing shall be performed using the highest gain antenna of each combination of transmitter and antenna type for which approval is being sought, with the transmitter output power set at the maximum level. Any antenna of the same type having equal or lesser gain as an antenna that had been successfully tested with the transmitter, will also be considered approved with the transmitter, and may be used and marketed with the transmitter.

When a measurement at the antenna connector is used to determine RF output power, the effective gain of the device's antenna shall be stated, based on measurement or on data from the antenna manufacturer. For transmitters of output power greater than 10 milliwatts, the total antenna gain shall be added to the measured RF output power to demonstrate compliance to the specified radiated power limits.

Testing of the RN2903 module was performed with the antenna types listed in Table 5-1 Tested External Antenna Types.

6.2.4 HELPFUL WEB SITES

Industry Canada: http://www.ic.gc.ca/

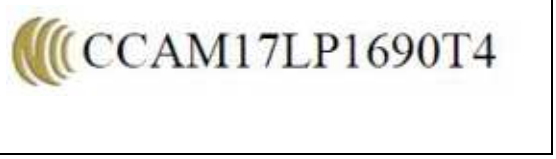
6.3 Taiwan

The RN2903 module has received compliance approval in accordance with the Telecommunications Act. Customers seeking to use the compliance approval in their product should contact Microchip Technology sales or distribution partners to obtain a Letter of Authority.

Integration of this module into a final product does not require additional radio certification provided installation instructions are followed and no modifications of the module are allowed.

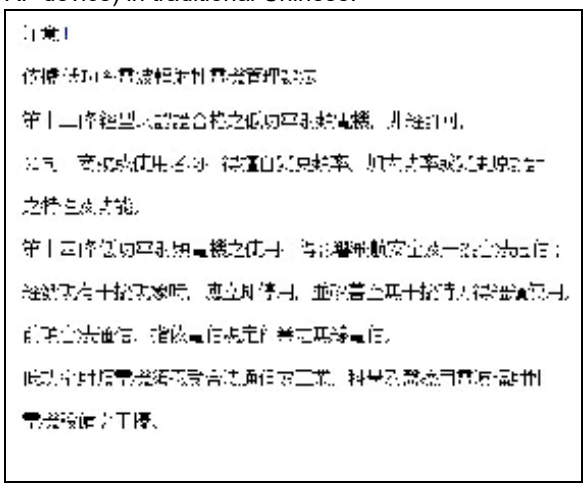
6.3.1 LABELING AND USER INFORMATION REQUIREMENTS

The RN2903 module is labeled with its own NCC mark and certificate number as below:



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The user's manual should contain below warning (for RF device) in traditional Chinese:



6.3.2 HELPFUL WEB SITES

National Communications Commission (NCC):
http://www.ncc.gov.tw

NOTES:

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APPENDIX A: REVISION HISTORY

Revision A (July 2015)

This is the initial release of this document.

Revision B (December 2015)

This revision includes the following updates:

- Updated Deep Sleep value in Table 2-3
- Updated Dimensions value in Table 2-4
- Updated Figure 4-1
- Updated Figure 4-2
- Updated Figure 5-2
- Updated information for **Section 5.1 “RF Trace Layout Design”**.

Revision C (February 2017)

This revision includes the following updates:

- Updated Figure 1-2 and Figure 3-1
- Updated Table 1-1, Table 2-2, Table 2-3, Table 2-5 and Table 5-1
- Added Table 2-6
- Updated **Section 3.4 “RESET Pin”**
- Added **Section 3.6 “Internal Program Pins”**, **Section 5.2 “PCB Trace Antenna”** and **Section 6.2.2 “RF EXPOSURE”**
- Deleted Section “5.4 Application Schematic”.

Revision D (October 2017)

This revision includes the following updates:

- Removed Australia and New Zealand from **Section 6.0 “Regulatory Approval”**.
- Updated General Features section to remove Australia and New Zealand.
- Updated General Features section to add Taiwan.
- Added Taiwan to **Section 6.0 “Regulatory Approval”**.

Revision E (January 2018)

This revision includes the following updates:

- Updated **Section 6.0 “Regulatory Approval”** to correct information for Taiwan.

NOTES:

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PRODUCT IDENTIFICATION SYSTEM

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PART NO.	I	RM	XXX
Device	Temperature Range	Package	Firmware Revision Number

Device:	RN2903A:		Low-Power Long Range LoRa® Technology Transceiver module
Temperature Range:	I	=	-40°C to +85°C (Industrial)
Package:	RM	=	Radio Module

Examples:

RN2903A-I/RM: Industrial temperature

NOTES:

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